

Data sheet Product ICK LED R 29 x 11,5 G



Heatsinks and active heatsinks for processors>Heatsinks for LEDs

Ø 29 x 11.5 mm, for IC design LED

Features

diameter:	29 mm
way of fixation:	<ul style="list-style-type: none"> • therm. conductive foil • therm. cond. adhesive
height:	11.5 mm
plate thickness:	3.5 mm
thermal resistance:	17.8 - 4 K/W
dissipation loss:	8 W
surface:	black anodised

Technical Drawing

